

General Description

The CMSA6354 uses advanced process technology and design to provide excellent $R_{DS(ON)}$. It can be used in a wide variety of applications.

Product Summary

BVDSS	RDS(on)	ID
30V	5.5mΩ	65A

Applications

- High side in DC - DC Buck Converters
- Notebook battery power management
- Load switch in Notebook

Features

- N-Channel MOSFET
- Low ON-resistance
- Surface Mount Package
- RoHS Compliant

DFN-8 5x6 Pin Configuration**Absolute Maximum Ratings**

Type	Package	Marking
CMSA6354	DFN-8 5x6	CMSA6354

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D @ T_c = 25^\circ C$	Continuous Drain Current	65	A
$I_D @ T_c = 100^\circ C$	Continuous Drain Current	45	A
I_{DM}	Pulsed Drain Current	195	A
EAS	Single Pulse Avalanche Energy ¹	132	mJ
$P_D @ T_c = 25^\circ C$	Total Power Dissipation	40	W
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient(Steady-State)	---	55	°C/W
$R_{\theta JC}$	Thermal Resistance Junction-case(Steady-State)	---	3.1	°C/W

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_D=250\mu\text{A}$	30	---	---	V
$R_{\text{DS}(\text{ON})}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=10\text{V}$, $I_D=20\text{A}$	---	4.6	5.5	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}$, $I_D=20\text{A}$	---	9.6	13	
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$, $I_D = 250\mu\text{A}$	1	---	3	V
I_{DSS}	Drain-Source Leakage Current	$V_{\text{DS}}=30\text{V}$, $V_{\text{GS}}=0\text{V}$	---	---	1	μA
I_{GSS}	Gate-Source Leakage Current	$V_{\text{GS}} = \pm 20\text{V}$	---	---	± 100	nA
g_{fs}	Forward Transconductance	$V_{\text{DS}}=5\text{V}$, $I_D=20\text{A}$	---	19	---	S
Q_g	Total Gate Charge	$V_{\text{DS}}=15\text{V}$, $I_D=20\text{A}$	---	17	---	nC
Q_{gs}	Gate-Source Charge		---	3.6	---	
Q_{gd}	Gate-Drain Charge		---	2.2	---	
$T_{\text{d}(\text{on})}$	Turn-On Delay Time	$V_{\text{DD}}=15\text{V}$, $V_{\text{GS}}=10\text{V}$, $R_G=3\Omega$	---	6	---	ns
T_r	Rise Time		---	3	---	
$T_{\text{d}(\text{off})}$	Turn-Off Delay Time		---	22	---	
T_f	Fall Time		---	3	---	
C_{iss}	Input Capacitance	$V_{\text{DS}}= 25\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$	---	1300	---	pF
C_{oss}	Output Capacitance		---	300	---	
C_{rss}	Reverse Transfer Capacitance		---	30	---	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_s	Diode continuous forward current	$V_G=V_D=0\text{V}$, Force Current	---	---	65	A
$I_{s,\text{pulse}}$	Diode pulse current		---	---	195	A
V_{SD}	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}$, $I_F=20\text{A}$, $T_J=25^\circ\text{C}$	---	0.87	1.2	V

Notes:

1.The EAS data shows Max. rating . The test condition is $V_{\text{DD}}=25\text{V}$, $V_{\text{GS}}=10\text{V}$, $L=0.5\text{mH}$, $I_{\text{AS}}=23\text{A}$

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Cmos assumes no liability for customers' product design or applications.

Cmos reserves the right to improve product design ,functions and reliability without notice.

N-Channel Enhancement Mode MOSFET

Typical Characteristics

